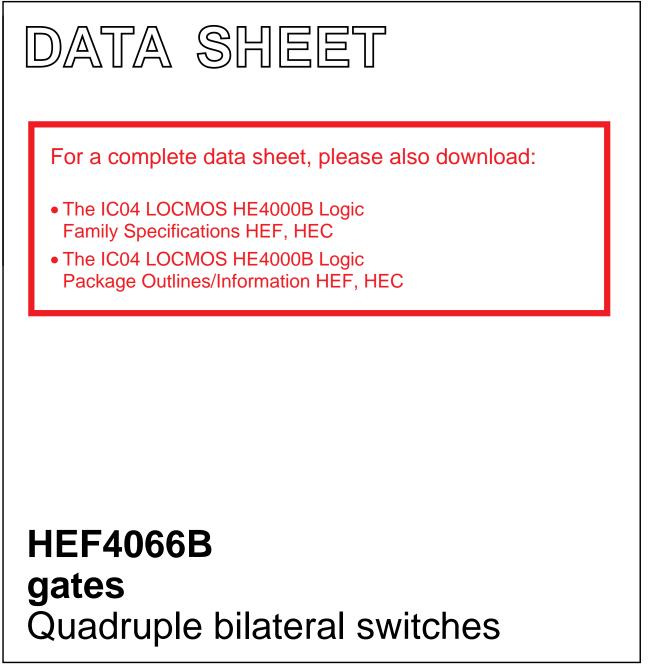
# INTEGRATED CIRCUITS



Product specification File under Integrated Circuits, IC04 January 1995



## QUADRUPLE BILATERAL SWITCHES

The HEF4066B has four independent bilateral analogue switches (transmission gates). Each switch has two input/output terminals (Y/Z) and an active HIGH enable input (E). When E is connected to  $V_{DD}$  a low impedance bidirectional path between Y and Z is established (ON condition). When E is connected to  $V_{SS}$  the switch is disabled and a high impedance between Y and Z is established (OFF condition).

The HEF4066B is pin compatible with the HEF4016B but exhibits a much lower ON resistance. In addition the ON resistance is relatively constant over the full input signal range.

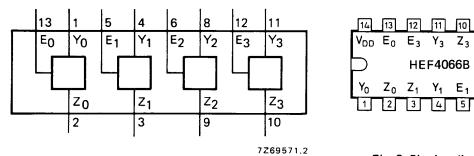


Fig. 2 Pinning diagram.

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Fig. 1 Functional diagram.

#### PINNING

 $E_0$  to  $E_3$  enable inputs  $Y_0$  to  $Y_3$  input/output terminals  $Z_0$  to  $Z_3$  input/output terminals HEF4066BP(N): 14-lead DIL; plastic (SOT27-1) HEF4066BD(F): 14-lead DIL; ceramic (cerdip) (SOT73)) HEF4066BT(D): 14-lead SO; plastic (SOT108-1) (): Package Designator North America

#### **APPLICATION INFORMATION**

An example of application for the HEF4066B is:

Analogue and digital switching

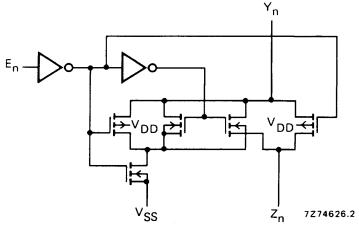


Fig. 3 Schematic diagram (one switch).

### RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134) Power dissipation per switch

For other RATINGS see Family Specifications

### D.C. CHARACTERISTICS

 $T_{amb} = 25 \text{ °C}$ 

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	V <sub>DD</sub> V	symbol	min.	typ.	max.		conditions
ON resistance	5 10 15	R <sub>ON</sub>		350 80 60	2500 245 175	Ω Ω Ω	$\begin{cases} E_n \text{ at } V_{DD} \\ V_{is} = V_{SS} \text{ to } V_{DD} \\ \text{see Fig. 4} \end{cases}$
ON resistance	5 10 15	R <sub>ON</sub>	-   -   -	115 50 40	340 160 115	Ω Ω Ω	E <sub>n</sub> at V <sub>DD</sub> V <sub>is</sub> = V <sub>SS</sub> see Fig. 4
ON resistance	5 10 15	R <sub>ON</sub>	- - -	120 65 50	365 200 155	Ω Ω Ω	E <sub>n</sub> at V <sub>DD</sub> V <sub>is</sub> = V <sub>DD</sub> see Fig. 4
'Δ' ON resistance between any two channels	5 10 15	ΔR <sub>ON</sub>	_ _ _	25 10 5	-	Ω Ω Ω	E <sub>n</sub> at V <sub>DD</sub> V <sub>is</sub> = V <sub>SS</sub> to V <sub>DD</sub> see Fig. 4
OFF state leakage current, any channel OFF	5 10 15	loz	-   -   -	  _	  200	nA nA nA	E <sub>n</sub> at V <sub>SS</sub>
E <sub>n</sub> input voltage LOW	5 10 15	VIL	-   -   -	2,25 4,50 6,75	1 2 2	V V V	$\begin{cases} I_{is} = 10 \ \mu A \\ see Fig. 9 \end{cases}$

	V <sub>DD</sub> V	symbol	T -40 max.	amb ( <sup>0</sup> ( + 25 max.	C) + 85 max.		conditions
Quiescent device current	5 10 15	IDD	1,0 2,0 4,0	1,0 2,0 4,0	7,5 15,0 30,0	μΑ μΑ μΑ	$\begin{cases} V_{SS} = 0; all valid \\ input combinations; \\ V_{I} = V_{SS} or V_{DD} \end{cases}$
Input leakage current at E <sub>n</sub>	15	±IN	_	300	1000	nA	E <sub>n</sub> at V <sub>SS</sub> or V <sub>DD</sub>

Product specification

HEF4066B

gates

P max. 100 mW

HEF4066B gates

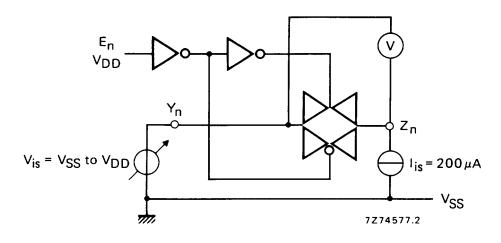


Fig. 4 Test set-up for measuring RON.

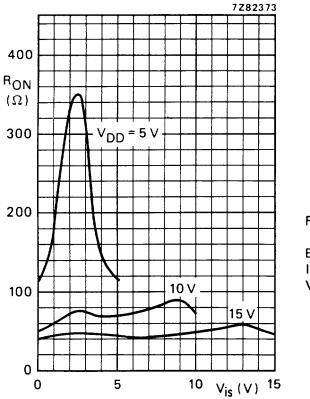


Fig. 5 Typical  $R_{\mbox{ON}}$  as a function of input voltage.

 $E_n \text{ at } V_{DD}$  $I_{is} = 200 \ \mu\text{A}$  $V_{SS} = 0 \ V$ 

### NOTE

To avoid drawing V<sub>DD</sub> current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0,4 V. If the switch current flows into terminal Z, no V<sub>DD</sub> current will flow out of terminals Y, in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V<sub>DD</sub> or V<sub>SS</sub>.

## HEF4066B gates

#### A.C. CHARACTERISTICS

 $V_{\mbox{\scriptsize SS}}$  = 0 V;  $T_{\mbox{\scriptsize amb}}$  = 25 °C; input transition times  $\leqslant$  20 ns

	V <sub>DD</sub> V	symbol	typ.	max.		
Propagation delays V <sub>is</sub> — V <sub>os</sub> HIGH to LOW LOW to HIGH	5 10 15 5 10	<sup>t</sup> PHL tPLH	10 5 5 10 5	20 10 10 20 10	ns ns ns ns ns	<pre>&gt; note 1 &gt; note 1</pre>
	15		5	10	ns	J
Output disable times E <sub>n</sub> → V <sub>os</sub> HIGH	5 10 15	<sup>t</sup> PHZ	80 65 60	160 130 120	ns ns ns	} note 2
LOW	5 10 15	<sup>t</sup> PLZ	80 70 70	160 140 140	ns ns ns	} note 2
Output enable times E <sub>n</sub> ─► V <sub>OS</sub> HIGH	5 10 15	<sup>t</sup> PZH	40 20 15	80 40 30	ns ns ns	} note 2
LOW	5 10 15	<sup>t</sup> PZL	45 20 15	90 40 30	ns ns ns	} note 2
Distortion, sine-wave response	5 10 15		0,25 0,04 0,04		% % %	} note 3
Crosstalk between any two channels	5 10 15		- 1 -		MHz MHz MHz	} note 4
Crosstalk; enable input to output	5 10 15		_ 50 _		mV mV mV	} note 5
OFF-state feed-through	5 10 15		_   1   _		MHz MHz MHz	} note 6
ON-state frequency response	5 10 15		 90 		MHz MHz MHz	} note 7
	V <sub>DD</sub> V	typical fo	rmula for	Ρ (μW)	where f <sub>i</sub> = input freq. (MHz) f <sub>o</sub> = output freq. (MHz)	
Dynamic power dissipation per package (P)	5 10 15	3 500 f <sub>i</sub>	+ Σ(f <sub>o</sub> CL + Σ(f <sub>o</sub> CL + Σ(f <sub>o</sub> CL	$\times V_{DD}^{2}$	$C_L$ = load capacitance (pF) $\Sigma(f_0C_L)$ = sum of outputs $V_{DD}$ = supply voltage (V)	

HEF4066B gates

#### NOTES

 $V_{is}$  is the input voltage at a Y or Z terminal, whichever is assigned as input.  $V_{os}$  is the output voltage at a Y or Z terminal, whichever is assigned as output.

- 1.  $R_L = 10 \text{ k}\Omega$  to  $V_{SS}$ ;  $C_L = 50 \text{ pF}$  to  $V_{SS}$ ;  $E_n = V_{DD}$ ;  $V_{is} = V_{DD}$  (square-wave); see Figs 6 and 10.
- 2.  $R_L = 10 k\Omega$ ;  $C_L = 50 pF$  to  $V_{SS}$ ;  $E_n = V_{DD}$  (square-wave);  $V_{is} = V_{DD}$  and  $R_L$  to  $V_{SS}$  for  $t_{PHZ}$  and  $t_{PZH}$ ;
  - $V_{is} = V_{SS}$  and  $R_{L}$  to  $V_{DD}$  for tpLZ and tpZL; see Figs 6 and 11.
- 3.  $R_L = 10 k\Omega$ ;  $C_L = 15 pF$ ;  $E_n = V_{DD}$ ;  $V_{is} = \frac{1}{2} V_{DD(p-p)}$  (sine-wave, symmetrical about  $\frac{1}{2} V_{DD}$ );  $f_{is} = 1 kHz$ ; see Fig. 7.
- 4.  $R_{L} = 1 k\Omega$ ;  $V_{is} = \frac{1}{2} V_{DD(p-p)}$  (sine-wave, symmetrical about  $\frac{1}{2} V_{DD}$ ); 20 log  $\frac{V_{os}(B)}{V_{is}(A)} = -50 dB$ ;  $E_{n}(A) = V_{SS}$ ;  $E_{n}(B) = V_{DD}$ ; see Fig. 8.
- 5.  $R_L = 10 \text{ k}\Omega$  to  $V_{SS}$ ;  $C_L = 15 \text{ pF}$  to  $V_{SS}$ ;  $E_n = V_{DD}$  (square-wave); crosstalk is  $|V_{OS}|$  (peak value); see Fig. 6.
- 6.  $R_L = 1 k\Omega$ ;  $C_L = 5 pF$ ;  $E_n = V_{SS}$ ;  $V_{is} = \frac{1}{2} V_{DD(p-p)}$  (sine-wave, symmetrical about  $\frac{1}{2} V_{DD}$ ); 20 log  $\frac{V_{os}}{V_{is}} = -50 dB$ ; see Fig. 7.
- 7.  $R_L = 1 k\Omega$ ;  $C_L = 5 pF$ ;  $E_n = V_{DD}$ ;  $V_{is} = \frac{1}{2} V_{DD(p-p)}$  (sine-wave, symmetrical about  $\frac{1}{2} V_{DD}$ ); 20 log  $\frac{V_{os}}{V_{is}} = -3 dB$ ; see Fig. 7.

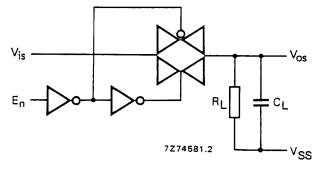


Fig. 6.

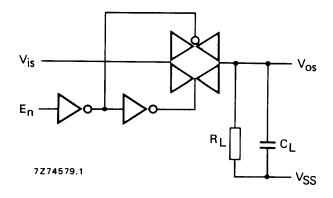


Fig. 7.

HEF4066B gates

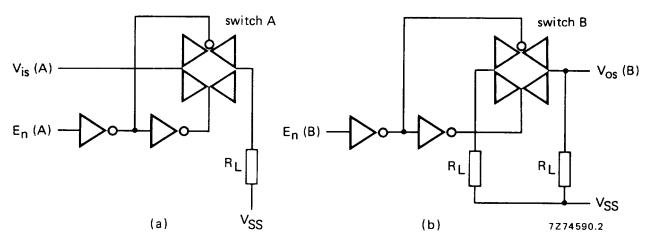


Fig. 8.

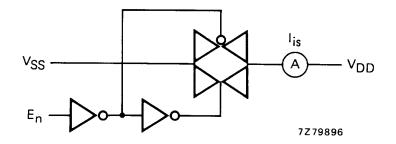


Fig. 9.

HEF4066B gates

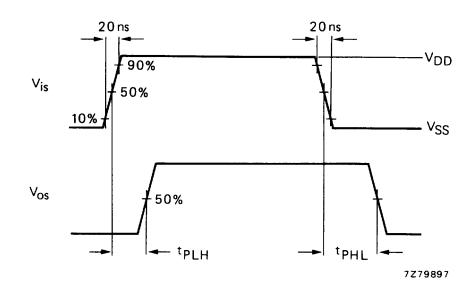
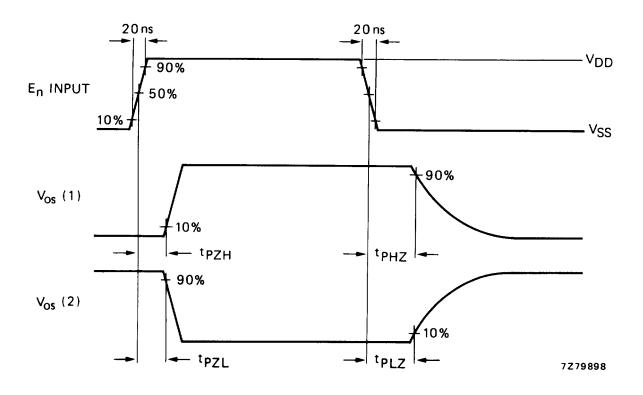


Fig. 10 Waveforms showing propagation delays from  $V_{is}$  to  $V_{os}$ .



(1)  $V_{is}$  at  $V_{DD}$ ; (2)  $V_{is}$  at  $V_{SS}$ .

Fig. 11 Waveforms showing output disable and enable times.